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To the Honorable Commissioner of Patent

1. Name of conveying party(ies)

Veselin BRANKOVIC, Dragan KRUPCEVIC, Mohamed RATNI, Hamid
AMIR-ALIKHANI, Kenichi KAWASAKI, Kazuji SASAKI, Keiji
FUKUZAWAAdditional name(s) of conveying party(ies) attached?
___ Yes ___ X No

2. Name and address of receiving party(ies)

Name: SONY International (Europe) GmbH
Kemperplatz 1
D-10785 Berlin
GERMANYSONY CORPORATION
6-7-35 Kitashinagawa, Shinagawa-Ku,
Tokyo 141-0001, JapanSONY ELECTRONICS INC.
1 Sony Drive, Park Ridge,
New Jersey 07656, USAAdditional name(s) & address(es) attached? ___ Yes ___ x No

3. Nature of conveyance:

X Assignment
___ Security Agreement
___ Merger
___ Change of Name
___ OtherExecution Date(s): November 6, November 6, November 6,
November 6, November 17, November 1 and November 1, 2000

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of
the application is:A. Patent Application No.(s) 09/593,178 filed June 13, 2000Additional numbers attached? ___ Yes ___ X No5. Name and address of party to whom correspondence
concerning document should be mailed:

Name: WILLIAM S. FROMMER

Internal Address: FROMMER LAWRENCE & HAUG LLP

Street Address: 745 FIFTH AVENUE

City: NEW YORK State: N.Y. Zip: 101516. Total number of applications and
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November 22, 2000

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PK2-1000C, Washington, D.C. 20231, and to the Office of Management and Budget, Paperwork Reduction Project (0651-0011),
Washington, D.C. 20503.

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

WIRELESS TRANSMISSION SYSTEM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY INTERNATIONAL (EUROPE) GmbH, a German corporation, with offices at Kemperplatz 1, D-10785, Berlin GERMANY, and SONY CORPORATION, a Japanese corporation with offices at 6-7-35 Kitashinagawa, Shinagawa-Ku, Tokyo 141-0001, JAPAN and SONY ELECTRONICS INC., a Delaware corporation with offices at 1 Sony Drive, Park Ridge, New Jersey 07656, USA (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 09/593,178, Filing Date: June 13, 2000.

This assignment executed on the dates indicated below.

Veselin BRANKOVIC

Name of first or sole inventor

Execution date of U.S. Patent Application

Stuttgart, Germany

Residence of first or sole inventor

6.14.2000

Signature of first or sole inventor

Date of this assignment

Dragan KRUPCEVIC

Name of second inventor

Execution date of U.S. Patent Application

Stuttgart, Germany

Residence of second inventor

6.14.2000

Signature of second inventor

Date of this assignment

Mohamed RATNI

Name of third inventor

Execution date of U.S. Patent Application

Stuttgart, Germany

Residence of third inventor

Nov 6th 2000

Signature of third inventor

Date of this assignment

ADDITIONAL INVENTORS

Hamid AMIR-ALIKHANI

Name of fourth inventor

Execution date of U.S. Patent Application

Stuttgart, Germany

Residence of fourth inventor

Signature of fourth inventor

6th Nov. 2000

Date of this assignment

Kenichi KAWASAKI

Name of fifth inventor

Execution date of U.S. Patent Application

San Diego, California

Residence of fifth inventor

Signature of fifth inventor

Nov. 17, 2000

Date of this assignment

Kazuji SASAKI

Name of sixth inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of sixth inventor

Signature of sixth inventor

Nov. 1, 2000

Date of this assignment

Keiji FUKUZAWA

Name of seventh inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of seventh inventor

Signature of seventh inventor

Nov. 1, 2000

Date of this assignment